Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowelevel parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
				Form Type Distribute					us Materials a	rials and Mfg Information				
upplie	r Information													
Company name*				Company unique ID			Unique ID Authority				Response Date*			
onsemi											2024-05-14			
Contact N	Name	Title - Contact]	Phone - Contact*				Email - Contact*				
Product-	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*	Title - Representative			1	Phone - Representative*				Email - Representative*				
Product-	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date	Version	Manufacturin	g Site	Weight*	UOM	Unit Type	
		2N62840	6284G BIP T03 NPN 20A		A 100V		2024-05-14		MX5		11991.172	2 mg	Each	
Ianufa	acturing Proccess Informa	tion												
	Terminal Plating / Grid Array Material		Terminal Base Alloy J-ST		J-STD-020 MSI	_ Rating	Peak Proc	ess Body Temper	ss Body Temperature Max Time at Pea		mperature Nui	mber of Reflow Cy	cles	
	SnAgCu		CU Alloy NA		NA		0	C	30		seconds 3			
omments	S													
or more	information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		'Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-6_								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	18.3	mg	Supplier	Silicon (Si)	7440-21-3		18.3	mg
Die Attach	795.56	mg	Supplier	Indium (In)	7440-74-6		39.778	mg
			Supplier	Silver (Ag)	7440-22-4		23.8668	mg
			A	Lead (Pb)	7439-92-1	7a	731.9152	mg
Lead Frame	11138.1	mg	В	Nickel (Ni)	7440-02-0		111.381	mg
			Supplier	Iron (Fe)	7439-89-6		11026.7188	mg
Plating	38.83	mg	Supplier	Silver (Ag)	7440-22-4		1.1649	mg
			Supplier	Tin (Sn)	7440-31-5		37.471	mg
			Supplier	Copper (Cu)	7440-50-8		0.1942	mg
Wire Bond - Al	0.382	mg	Supplier	Aluminum (Al)	7429-90-5		0.382	mg